

NCP781

150 V, 100 mA Very High Voltage Linear Regulator

The NCP781 is a very high-voltage tolerant linear regulator that offers the benefits of thermally enhanced DFN6 3.3 x 3.3 package and is able to withstand continuous DC or transient input voltages up to 150 V. The device is stable with small 0.1 μF Ceramic Output Capacitors which allows smaller PCB design at space constraining applications. The devices features enable pin compatible with standard CMOS logic.

Features

- Wide Input Voltage Range: 6 V to 150 V
- Output Voltage Versions:
 - Fixed: 3.3 V, 5 V, 15 V
 - Adjustable: from 1.23 V up to 15 V
- $\pm 2.5\%$ Accuracy at Room Temperature
- Very Low Quiescent Current of Typ. 25 μA
- Standby Current: 1 μA
- Stable with a 0.1 μF Ceramic Output Capacitor
- Very High PSRR: 83/56 dB@1/100 kHz
- Thermal Shutdown and Current Limit Protection
- Available in Thermally Enhanced DFN6 3.3 x 3.3, 0.65P Package
- Ideal for Harsh Environments
- These are Pb-free Devices

Typical Applications

- Telecom, Industrial
- Bias Power Supplies, Led Lighting

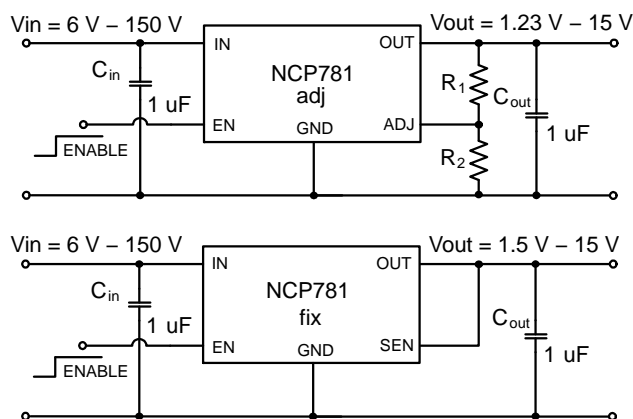


Figure 1. Typical Applications



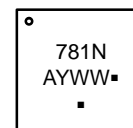
ON Semiconductor®

www.onsemi.com



DFN6
S SUFFIX
CASE 506DF

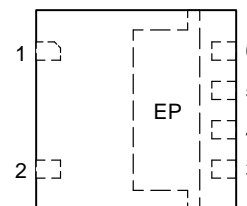
MARKING DIAGRAM



781N = Specific Device Code
A = Assembly Location
Y = Year
WW = Work Week
▪ = Pb-Free Package

(Note: Microdot may be in either location)

PIN CONNECTION



(Top View)

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 13 of this data sheet.

NCP781

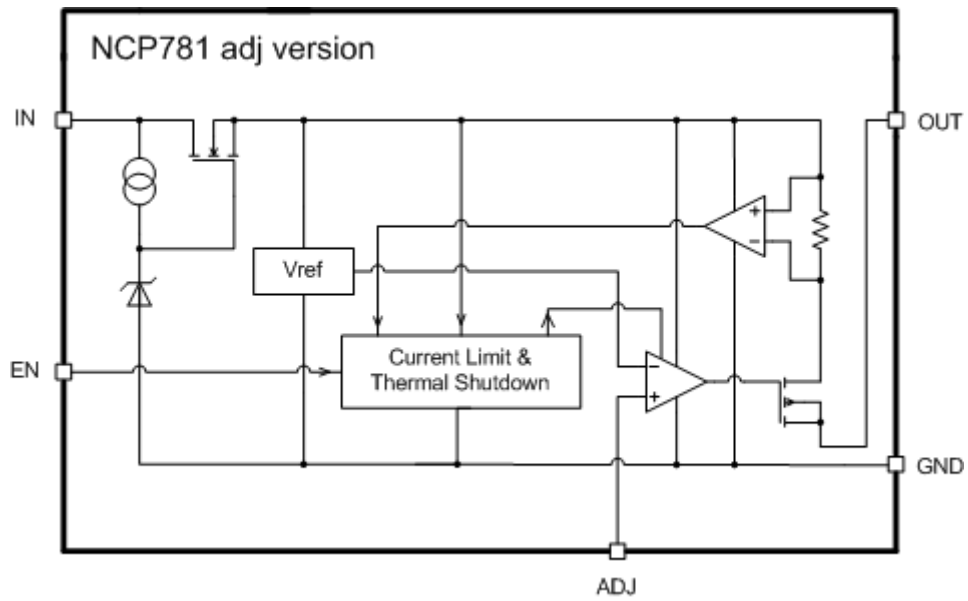


Figure 2. Simplified Block Diagram for Adjustable Version

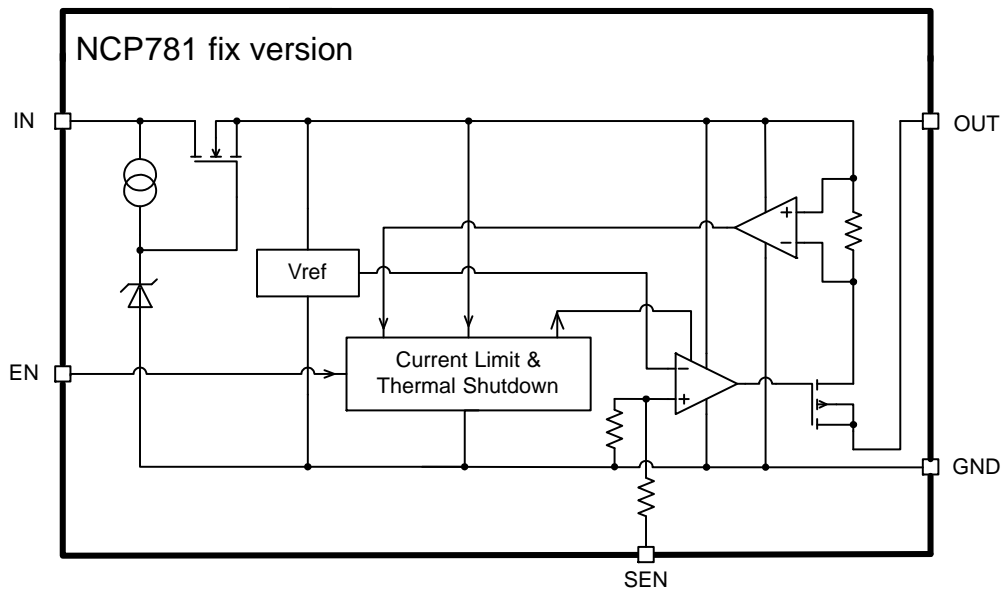


Figure 3. Simplified Block Diagram for Fixed Version

NCP781

Table 1. PIN FUNCTION DESCRIPTION

Pin No. DFN6 3.3 x 3.3	Pin Name	Description
1	IN	Positive Power Supply Input
2	EN	Chip Enable pin (Active "H")
3	NC	Not Connected
4	GND	Power Supply Ground
5	OUT	Regulated Output Voltage
6	ADJ/SEN	Output Voltage Adjust Input (Adjustable Version), Sense pin for output voltage sensing, connect to pin 5 (Fixed Voltage Versions)
EP	EP	EP should be connected to GND potential

ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Input Voltage Range (Note 1)	V_{IN}	150	V
Output Voltage Range (Note 2)	V_{OUT}	-0.3 to 20 V	V
Enable Input Range	V_{EN}	-0.3 to ($V_{in} + 0.3$) V	V
Adjustable Input Range	V_{ADJ}	-0.3 to 5 V	V
Output Short Circuit Duration	t_{sc}	unlimited	s
Maximum Junction Temperature	$T_{J(max)}$	150	°C
Storage Temperature Range	TSTG	-55 to 150	°C
ESD Capability, Human Body Model (Notes 3, 4)	ESDHBM	2	kV
ESD Charged Device Model ESD (Notes 3, 4)	ESDCDM	750	V
Moisture Sensitivity Level	MSL	1	-
Lead Temperature Soldering Reflow (SMD Styles Only), Pb-Free Versions (Note 5)	T_{SLD}	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Refer to ELECTRICAL CHARACTERISTIC and APPLICATION INFORMATION for Safe operating Area
2. The device has limited reverse bias protection. Reverse bias protection feature valid only if ($V_{OUT} - V_{IN}$) < 7 V.
3. This device series incorporates ESD protection and is tested by the following methods:
 ESD Human Body Model tested per AEC-Q100-002 (EIA/JESD22-A114)
 ESD Charged-Device Model ESD Capability per JEDEC JSD22-C101E
 Latchup Current Maximum Rating: ≤ 150 mA per JEDEC standard: JESD78
4. Except IN and EN pins.
5. For information, please refer to our Soldering and Mounting Techniques Reference Manual, SOLDERRM/D

Table 2. THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal Characteristics, DFN6, 3.3 x 3.3 mm (Note 6) Thermal Resistance, Junction-to-Air (Note 7)	$R_{\theta JA}$	125	°C/W

6. Refer to ELECTRICAL CHARACTERISTICS, RECOMMENDED OPERATING RANGES and/or APPLICATION INFORMATION for Safe Operating parameters.
7. Values based on copper area of 645 mm² (or 1 in²) of 1 oz copper thickness and FR4 PCB substrate.

NCP781

Table 3. ELECTRICAL CHARACTERISTICS – Adjustable $-40^{\circ}\text{C} \leq T_J \leq 125^{\circ}\text{C}$; $V_{IN} = V_{outnom} + 10\text{ V}$, $C_{IN} = C_{OUT} = 1\ \mu\text{F}$, unless otherwise noted. Typical values are at $T_A = +25^{\circ}\text{C}$. (Notes 8, 9)

Parameter	Test Conditions	Symbol	Min	Typ	Max	Unit
-----------	-----------------	--------	-----	-----	-----	------

INPUT REGULATOR

Operating Input Voltage		V_{IN}	6		150	V
-------------------------	--	----------	---	--	-----	---

OUTPUT REGULATOR

Reference Voltage Accuracy	$-40^{\circ}\text{C} \leq T_J \leq 125^{\circ}\text{C}$, $I_{OUT} = 50\ \mu\text{A}$ $6\text{ V} \leq V_{IN} \leq 150\text{ V}$		-3%	1.23 V	+3%	%
Reference Voltage Accuracy	$T_J = 25^{\circ}\text{C}$, $I_{OUT} = 50\ \mu\text{A}$ $6\text{ V} \leq V_{IN} \leq 150\text{ V}$		-2.5%	1.23 V	+2.5%	%
Line Regulation	$15\text{ V} \leq V_{IN} \leq 150\text{ V}$ $I_{OUT} = 50\ \mu\text{A}$	Reg_{line}		0.25	0.5	% V_{out}
Load Regulation		Reg_{load}		0.4	0.8	% V_{out}
Dropout Voltage (Note 10)	$V_{DO} = V_{IN} - (V_{OUT} - (3\%V_{outnom}))$ $I_{OUT} = 100\text{ mA}$	V_{DO}	-	4	6.5	V
3.3 V			-	4	7.0	
5.0 V			-	4.4	7.5	
12.0 V			-	4.7	9.5	
15.0 V			-			

DISABLE, QUIESCENT AND GROUND CURRENTS

Disable Current	$V_{EN} = 0\text{ V}$, $V_{IN} = 150\text{ V}$	I_{DIS}	-	1	10	μA
Quiescent Current	$I_{OUT} = 0\text{ mA}$	I_Q	-	25	55	μA
Ground Current	$I_{OUT} = 100\text{ mA}$	I_{GND}	-	250	400	μA
Enable Pin Current	$1.5\text{ V} < V_{EN} < 150\text{ V}$	I_{EN}		500		nA
ADJ Pin Current	$6\text{ V} < V_{IN} < 150\text{ V}$, $\text{ADJ} = V_{OUT}$	I_{ADJ}		5		nA

CURRENT LIMIT PROTECTION

Current Limit (Note 11)	$V_{OUT} = V_{OUTNOM} - (10\% V_{OUTNOM})$	I_{LIM}	110			mA
Short Circuit Current Limit	$V_{OUT} = 0\text{ V}$, $V_{in} = 25\text{ V}$	I_{SC}		220		mA

ENABLE THRESHOLDS

Enable Input Threshold Voltage		$V_{TH(EN)}$	1.5	-	-	V
Voltage Increasing, Logic High	High					
Voltage Decreasing, Logic Low	Low		-	-	0.4	

PSRR AND NOISE

Power Supply Ripple Rejection (Note 12)	$V_{IN} = 25\text{ V} + 200\text{ mV}_{pp}$ modulation $V_{OUT} = 1.23\text{ V}$, $C_{out} = 1.0\ \mu\text{F}$ $I_{OUT} = 10\text{ mA}$ $f = 1\text{ kHz}$ $f = 10\text{ kHz}$ $f = 100\text{ kHz}$	PSRR	-	83	-	dB
			-	75	-	
			-	56	-	
Output Noise Voltage (Note 12)	$V_{out} = 1.23\text{ V}$, $V_{in} = 150\text{ V}$ $I_{OUT} = 1\text{ mA}$, $C_{out} = 1.0\ \mu\text{F}$ $f = 100\text{ Hz}$ to 100 kHz	V_{NOISE}	-	130	-	μV_{rms}

THERMAL SHUTDOWN

Thermal Shutdown Temperature (Note 12)		T_{SD}	-	160	-	$^{\circ}\text{C}$
Thermal Shutdown Hysteresis (Note 12)		T_{SH}	-	15	-	$^{\circ}\text{C}$

8. Performance guaranteed over the indicated operating temperature range by design and characterization production tested at $T_J = T_A = 25^{\circ}\text{C}$. Low duty cycle pulse techniques are used during testing to maintain the junction temperature as close to ambient as possible.
9. $I_{OUT} > 50\ \mu\text{A}$ at $V_{IN} > 50\text{ V}$
10. Not characterized at $V_{OUTNOM} < 3.3\text{ V}$.
11. Respect to SOA
12. Guaranteed by design and characterization

NCP781

Table 4. ELECTRICAL CHARACTERISTICS – 3.3 V $-40^{\circ}\text{C} \leq T_J \leq 125^{\circ}\text{C}$; $V_{\text{OUT}} = 3.3\text{ V}$ typical, $V_{\text{IN}} = 13.3\text{ V}$, $C_{\text{IN}} = C_{\text{OUT}} = 1\ \mu\text{F}$, unless otherwise noted. Typical values are at $T_A = +25^{\circ}\text{C}$. (Notes 13, 14)

Parameter	Test Conditions	Symbol	Min	Typ	Max	Unit
INPUT REGULATOR						
Operating Input Voltage		V_{IN}	6		150	V
OUTPUT REGULATOR						
Output Voltage Accuracy	$-40^{\circ}\text{C} \leq T_J \leq 125^{\circ}\text{C}$ $(V_{\text{OUTNOM}} + 10\text{ V}) \leq V_{\text{IN}} \leq 150\text{ V}$		-3%	3.3	+3%	V
Output Voltage Accuracy	$T_J = 25^{\circ}\text{C}$, $I_{\text{OUT}} = 50\ \mu\text{A}$ $(V_{\text{OUTNOM}} + 10\text{ V}) \leq V_{\text{IN}} \leq 150\text{ V}$		-2.5%	3.3	+2.5%	V
Line Regulation	$15\text{ V} \leq V_{\text{IN}} \leq 150\text{ V}$ $I_{\text{OUT}} = 50\ \mu\text{A}$	Reg_{line}		8.3	16.5	mV
Load Regulation (Note 16)	$V_{\text{IN}} = 13.3\text{ V}$	Reg_{load}		13.2	26.5	mV
Dropout Voltage (Note 15)	$I_{\text{OUT}} = 100\text{ mA}$	V_{DO}		4.0	6.5	V
DISABLE, QUIESCENT AND GROUND CURRENTS						
Disable Current	$V_{\text{EN}} = 0\text{ V}$, $V_{\text{IN}} = 150\text{ V}$	I_{DIS}	-	1	10	μA
Quiescent Current	$I_{\text{OUT}} = 0\text{ mA}$	I_{Q}	-	27	57	μA
Ground Current	$I_{\text{OUT}} = 100\text{ mA}$	I_{GND}	-	250	400	μA
Enable pin current	$1.5\text{ V} < V_{\text{EN}} < 150\text{ V}$	I_{EN}		500		nA
CURRENT LIMIT PROTECTION						
Current Limit (Note 16)	$V_{\text{OUT}} = V_{\text{OUTNOM}} - (10\% V_{\text{OUTNOM}})$	I_{LIM}	110			mA
Short Circuit Current Limit	$V_{\text{OUT}} = 0\text{ V}$, $V_{\text{in}} = 25\text{ V}$	I_{SC}		220		mA
ENABLE THRESHOLDS						
Enable Input Threshold Voltage Voltage Increasing, Logic High Voltage Decreasing, Logic Low	High Low	$V_{\text{TH(EN)}}$	1.5 -	- -	- 0.4	V
PSRR AND NOISE						
Power Supply Ripple Rejection (Note 17)	$V_{\text{IN}} = 25\text{ V} + 200\text{ mV}_{\text{pp}}$ modulation $V_{\text{OUT}} = 3.3\text{ V}$, $C_{\text{OUT}} = 1.0\ \mu\text{F}$ $I_{\text{OUT}} = 10\text{ mA}$ $f = 1\text{ kHz}$ $f = 10\text{ kHz}$ $f = 100\text{ kHz}$	PSRR	- - -	75 62 48	- - -	dB
Output Noise Voltage (Note 17)	$V_{\text{out}} = 3.3\text{ V}$, $V_{\text{in}} = 150\text{ V}$ $I_{\text{OUT}} = 1\text{ mA}$, $C_{\text{OUT}} = 1.0\ \mu\text{F}$ $f = 100\text{ Hz to } 100\text{ kHz}$	V_{NOISE}	-	260	-	μV_{rms}
THERMAL SHUTDOWN						
Thermal Shutdown Temperature (Note 17)		T_{SD}	-	160	-	$^{\circ}\text{C}$
Thermal Shutdown Hysteresis (Note 17)		T_{SH}	-	15	-	$^{\circ}\text{C}$

13. Performance guaranteed over the indicated operating temperature range by design and characterization production tested at $T_J = T_A = 25^{\circ}\text{C}$.

Low duty cycle pulse techniques are used during testing to maintain the junction temperature as close to ambient as possible.

14. $I_{\text{OUT}} > 50\ \mu\text{A}$ at $V_{\text{IN}} > 50\text{ V}$

15. Characterized when V_{OUT} falls 99 mV below the regulated voltage and only for devices with $V_{\text{OUTNOM}} = 3.3\text{ V}$

16. Respect to SOA

17. Guaranteed by design and characterization

NCP781

Table 5. ELECTRICAL CHARACTERISTICS – 5.0 V $-40^{\circ}\text{C} \leq T_J \leq 125^{\circ}\text{C}$; $V_{\text{OUT}} = 5.0\text{ V}$ typical, $V_{\text{IN}} = 15\text{ V}$, $C_{\text{IN}} = C_{\text{OUT}} = 1\ \mu\text{F}$, unless otherwise noted. Typical values are at $T_A = +25^{\circ}\text{C}$. (Notes 18, 19)

Parameter	Test Conditions	Symbol	Min	Typ	Max	Unit
-----------	-----------------	--------	-----	-----	-----	------

INPUT REGULATOR

Operating Input Voltage		V_{IN}	6		150	V
-------------------------	--	-----------------	---	--	-----	---

OUTPUT REGULATOR

Output Voltage Accuracy	$-40^{\circ}\text{C} \leq T_J \leq 125^{\circ}\text{C}$ $(V_{\text{OUTNOM}} + 10\text{ V}) \leq V_{\text{IN}} \leq 150\text{ V}$		-3%	5.0	+3%	V
Output Voltage Accuracy	$T_J = 25^{\circ}\text{C}$, $I_{\text{OUT}} = 50\ \mu\text{A}$ $(V_{\text{OUTNOM}} + 10\text{ V}) \leq V_{\text{IN}} \leq 150\text{ V}$		-2.5%	5.0	+2.5%	V
Line Regulation	$15\text{ V} \leq V_{\text{IN}} \leq 150\text{ V}$ $I_{\text{OUT}} = 50\ \mu\text{A}$	Reg _{line}		12.5	25	mV
Load Regulation (Note 21)	$V_{\text{IN}} = 15\text{ V}$, $50\ \mu\text{A} \leq I_{\text{OUT}} \leq 100\text{ mA}$	Reg _{load}		20	40	mV
Dropout Voltage (Note 20)		V_{DO}		4	7.0	V

DISABLE, QUIESCENT AND GROUND CURRENTS

Disable Current	$V_{\text{EN}} = 0\text{ V}$, $V_{\text{IN}} = 150\text{ V}$	I_{DIS}	-	1	10	μA
Quiescent Current	$I_{\text{OUT}} = 0\text{ mA}$	I_{Q}	-	27	57	μA
Ground Current	$I_{\text{OUT}} = 100\text{ mA}$	I_{GND}	-	250	400	μA
Enable pin current	$1.5\text{ V} < V_{\text{EN}} < 150\text{ V}$	I_{EN}		500		nA

CURRENT LIMIT PROTECTION

Current Limit (Note 21)	$V_{\text{OUT}} = V_{\text{OUTNOM}} - (10\% V_{\text{OUTNOM}})$	I_{LIM}	110			mA
Short Circuit Current Limit	$V_{\text{OUT}} = 0\text{ V}$, $V_{\text{in}} = 25\text{ V}$	I_{SC}		220		mA

ENABLE THRESHOLDS

Enable Input Threshold Voltage Voltage Increasing, Logic High Voltage Decreasing, Logic Low	High Low	$V_{\text{TH(EN)}}$	1.5 -	- -	- 0.4	V
---	-------------	---------------------	----------	--------	----------	---

PSRR AND NOISE

Power Supply Ripple Rejection (Note 22)	$V_{\text{IN}} = 25\text{ V} + 200\text{ mV}_{\text{pp}}$ modulation $V_{\text{OUT}} = 5.0\text{ V}$, $C_{\text{OUT}} = 1.0\ \mu\text{F}$ $I_{\text{OUT}} = 10\text{ mA}$ $f = 1\text{ kHz}$ $f = 10\text{ kHz}$ $f = 100\text{ kHz}$	PSRR	- - -	65 56 45	- - -	dB
Output Noise Voltage (Note 22)	$V_{\text{out}} = 5.0\text{ V}$, $V_{\text{in}} = 150\text{ V}$ $I_{\text{OUT}} = 1\text{ mA}$, $C_{\text{OUT}} = 1.0\ \mu\text{F}$ $f = 100\text{ Hz to } 100\text{ kHz}$	V_{NOISE}	-	300	-	μV_{rms}

THERMAL SHUTDOWN

Thermal Shutdown Temperature (Note 22)		T_{SD}	-	160	-	$^{\circ}\text{C}$
Thermal Shutdown Hysteresis (Note 22)		T_{SH}	-	15	-	$^{\circ}\text{C}$

18. Performance guaranteed over the indicated operating temperature range by design and characterization production tested at $T_J = T_A = 25^{\circ}\text{C}$.

Low duty cycle pulse techniques are used during testing to maintain the junction temperature as close to ambient as possible.

19. $I_{\text{OUT}} > 50\ \mu\text{A}$ at $V_{\text{IN}} > 50\text{ V}$

20. Characterized when V_{OUT} falls 150 mV below the regulated voltage and only for devices with $V_{\text{OUTNOM}} = 5.0\text{ V}$

21. Respect to SOA

22. Guaranteed by design and characterization

NCP781

Table 6. ELECTRICAL CHARACTERISTICS – 15 V $-40^{\circ}\text{C} \leq T_J \leq 125^{\circ}\text{C}$; $V_{\text{OUT}} = 15.0\text{ V}$ typical, $V_{\text{IN}} = 25\text{ V}$, $C_{\text{IN}} = C_{\text{OUT}} = 1\ \mu\text{F}$, unless otherwise noted. Typical values are at $T_A = +25^{\circ}\text{C}$. (Notes 23, 24)

Parameter	Test Conditions	Symbol	Min	Typ	Max	Unit
INPUT REGULATOR						
Operating Input Voltage		V_{IN}	6		150	V
OUTPUT REGULATOR						
Output Voltage Accuracy	$-40^{\circ}\text{C} \leq T_J \leq 125^{\circ}\text{C}$ $(V_{\text{OUTNOM}} + 10\text{ V}) \leq V_{\text{IN}} \leq 150\text{ V}$		-3%	15.0	+3%	V
Output Voltage Accuracy	$T_J = 25^{\circ}\text{C}$, $I_{\text{OUT}} = 50\ \mu\text{A}$ $(V_{\text{OUTNOM}} + 10\text{ V}) \leq V_{\text{IN}} \leq 150\text{ V}$		-2.5%	15.0	+2.5%	V
Line Regulation	$25\text{ V} \leq V_{\text{IN}} \leq 150\text{ V}$ $I_{\text{OUT}} = 50\ \mu\text{A}$	Reg _{line}		37.5	75	mV
Load Regulation (Note 26)	$V_{\text{IN}} = 25\text{ V}$, $50\ \mu\text{A} \leq I_{\text{OUT}} \leq 100\text{ mA}$	Reg _{load}		60	120	mV
Dropout Voltage (Note 25)		V_{DO}		4.7	9.5	V
DISABLE, QUIESCENT AND GROUND CURRENTS						
Disable Current	$V_{\text{EN}} = 0\text{ V}$, $V_{\text{IN}} = 150\text{ V}$	I_{DIS}	-	1	10	μA
Quiescent Current	$I_{\text{OUT}} = 0\text{ mA}$	I_{Q}	-	27	57	μA
Ground Current	$I_{\text{OUT}} = 100\text{ mA}$	I_{GND}	-	250	400	μA
Enable pin current	$1.5\text{ V} < V_{\text{EN}} < 150\text{ V}$	I_{EN}		500		nA
CURRENT LIMIT PROTECTION						
Current Limit (Note 26)	$V_{\text{OUT}} = V_{\text{OUTNOM}} - (3\% V_{\text{OUTNOM}})$	I_{LIM}	110			mA
Short Circuit Current Limit	$V_{\text{OUT}} = 0\text{ V}$, $V_{\text{in}} = 25\text{ V}$	I_{SC}		220		mA
ENABLE THRESHOLDS						
Enable Input Threshold Voltage Voltage Increasing, Logic High Voltage Decreasing, Logic Low	High Low	$V_{\text{TH(EN)}}$	1.5 -	- -	- 0.4	V
PSRR AND NOISE						
Power Supply Ripple Rejection (Note 27)	$V_{\text{IN}} = 25\text{ V} + 200\text{ mV}_{\text{pp}}$ modulation $V_{\text{OUT}} = 15\text{ V}$, $C_{\text{OUT}} = 1.0\ \mu\text{F}$ $I_{\text{OUT}} = 10\text{ mA}$ $f = 1\text{ kHz}$ $f = 10\text{ kHz}$ $f = 100\text{ kHz}$	PSRR	- - -	53 50 43	- - -	dB
Output Noise Voltage (Note 27)	$V_{\text{out}} = 15\text{ V}$, $V_{\text{in}} = 150\text{ V}$ $I_{\text{OUT}} = 1\text{ mA}$, $C_{\text{OUT}} = 1.0\ \mu\text{F}$ $f = 100\text{ Hz to } 100\text{ kHz}$	V_{NOISE}	-	530	-	μV_{rms}
THERMAL SHUTDOWN						
Thermal Shutdown Temperature (Note 27)		T_{SD}	-	160	-	$^{\circ}\text{C}$
Thermal Shutdown Hysteresis (Note 27)		T_{SH}	-	15	-	$^{\circ}\text{C}$

23. Performance guaranteed over the indicated operating temperature range by design and characterization production tested at $T_J = T_A = 25^{\circ}\text{C}$.

Low duty cycle pulse techniques are used during testing to maintain the junction temperature as close to ambient as possible.

24. $I_{\text{OUT}} > 50\ \mu\text{A}$ at $V_{\text{IN}} > 50\text{ V}$

25. Characterized when V_{OUT} falls 450 mV below the regulated voltage and only for devices with $V_{\text{OUTNOM}} = 15.0\text{ V}$

26. Respect to SOA

27. Guaranteed by design and characterization

NCP781

TYPICAL CHARACTERISTICS

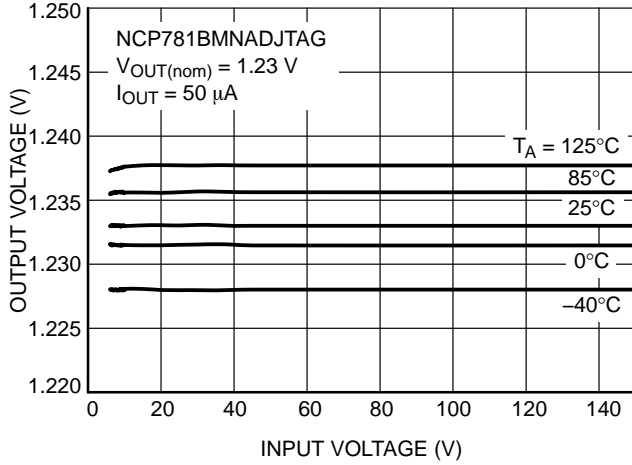


Figure 4. Output Voltage vs. Input Voltage at NCP781BMNADJTAG

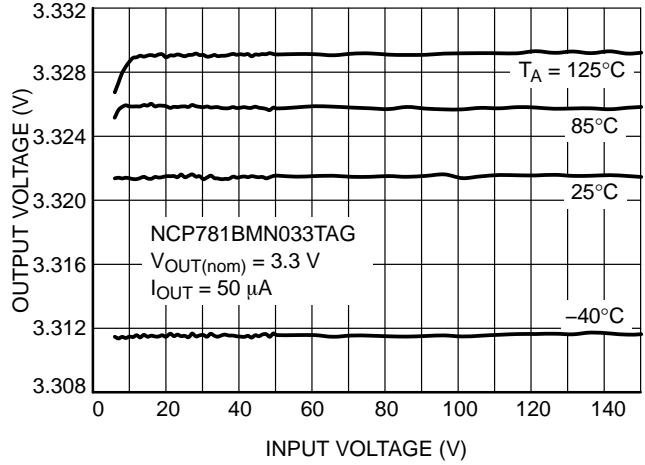


Figure 5. Output Voltage vs. Input Voltage at NCP781BMN033TAG

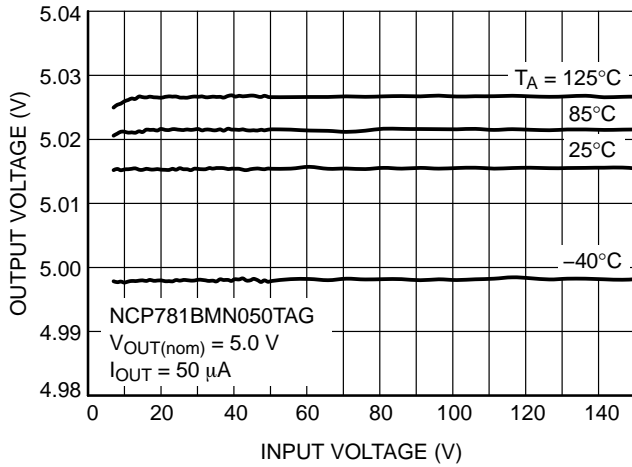


Figure 6. Output Voltage vs. Input Voltage at NCP781BMN050TAG

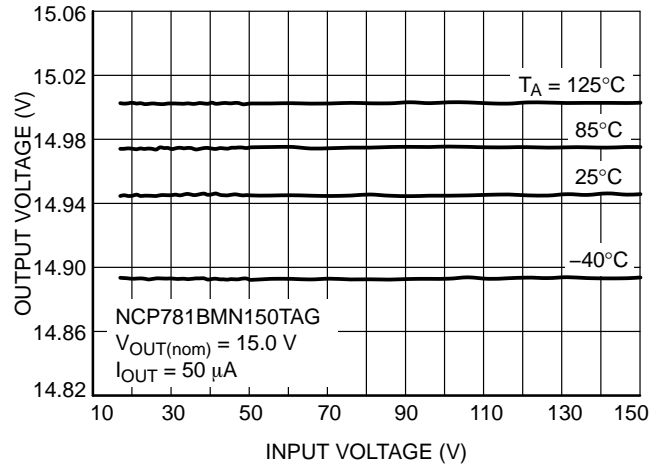


Figure 7. Output Voltage vs. Input Voltage at NCP781BMN150TAG

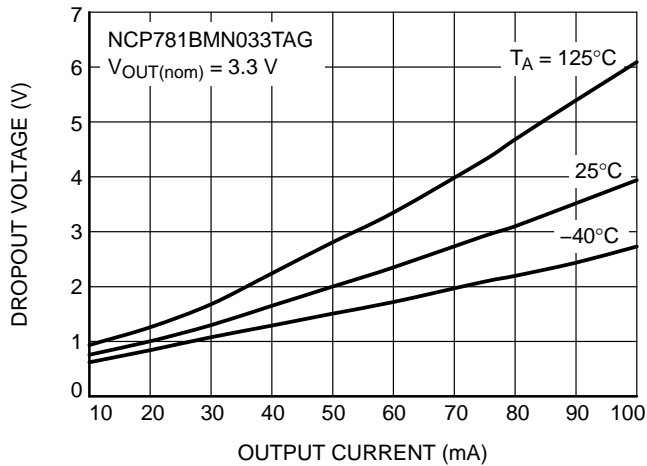


Figure 8. Dropout Voltage vs. Output Current at NCP781BMN033TAG

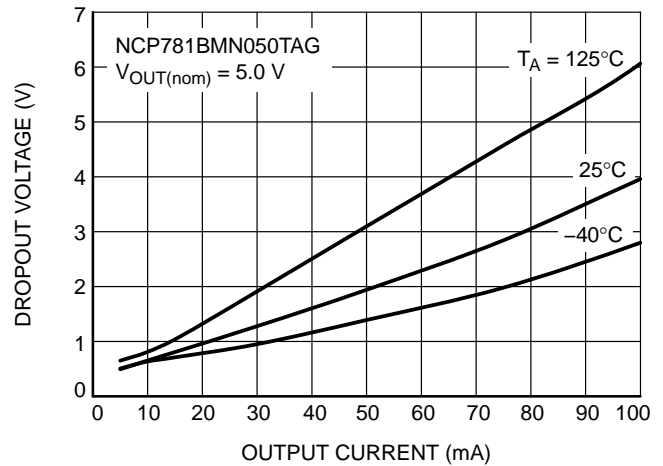


Figure 9. Dropout Voltage vs. Output Current at NCP781BMN050TAG

NCP781

TYPICAL CHARACTERISTICS

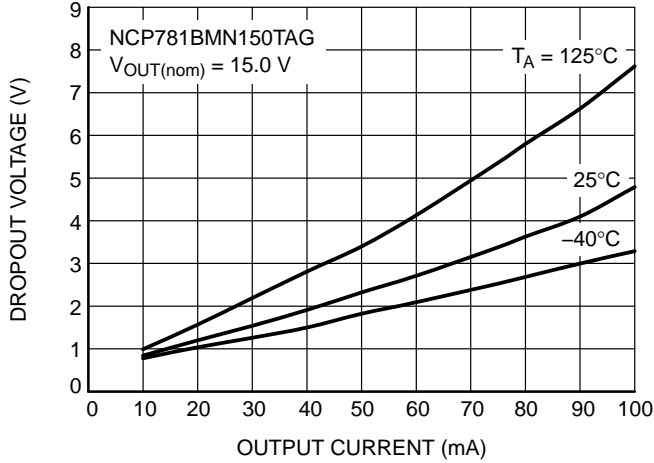


Figure 10. Dropout Voltage vs. Output Current at NCP781BMN150TAG

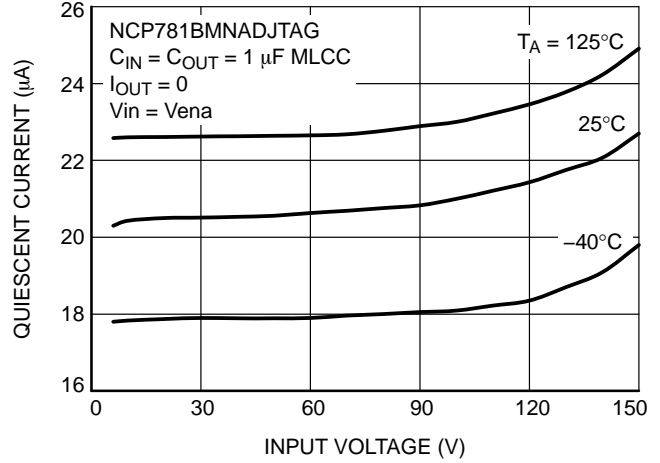


Figure 11. Quiescent Current vs. Input Voltage at NCP781BMNADJTAG

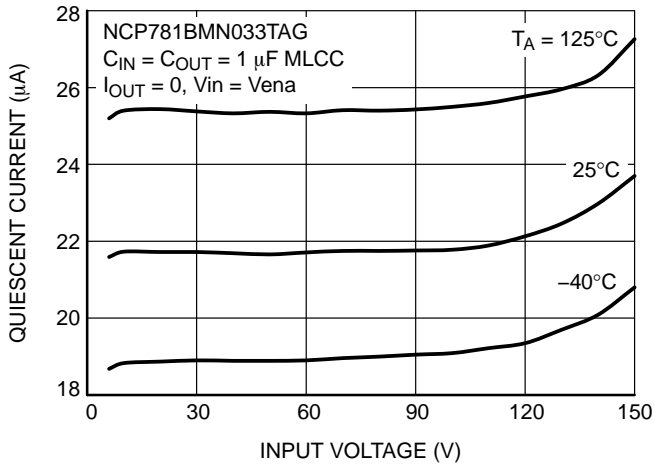


Figure 12. Quiescent Current vs. Input Voltage at NCP781BMN033TAG

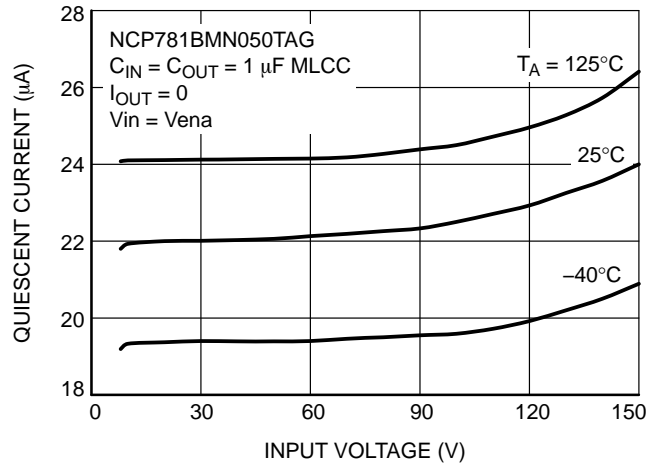


Figure 13. Quiescent Current vs. Input Voltage at NCP781BMN050TAG

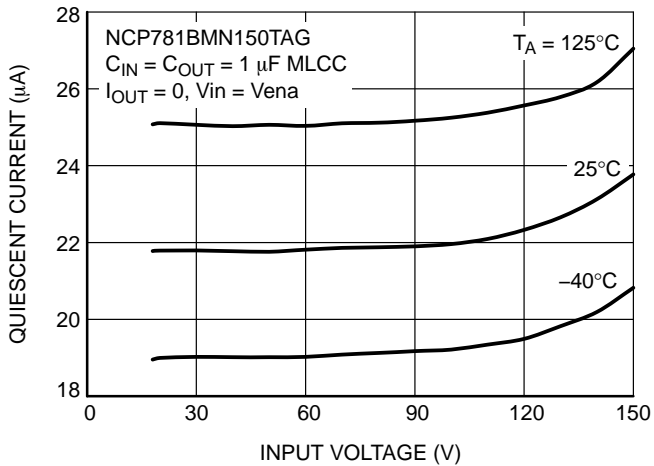


Figure 14. Quiescent Current vs. Input Voltage at NCP781BMN150TAG

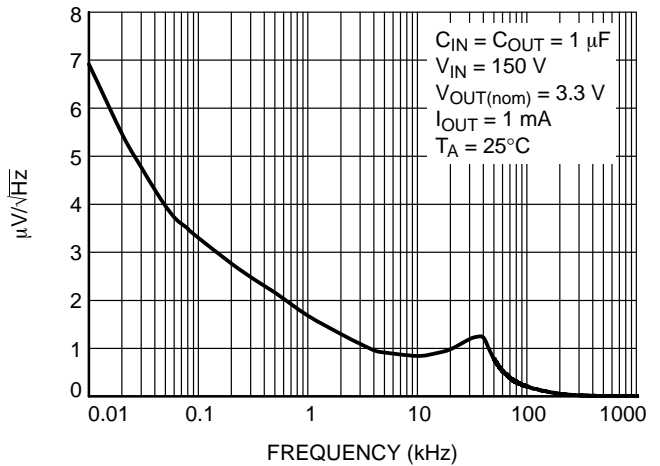


Figure 15. Output Voltage Noise Spectral Density at NCP781BMN033TAG

NCP781

TYPICAL CHARACTERISTICS

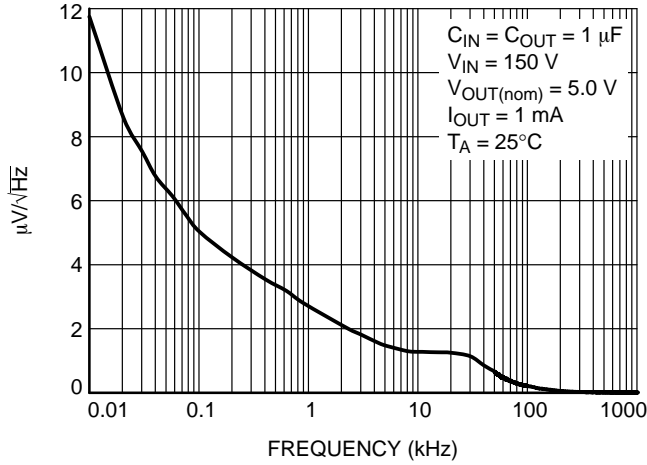


Figure 16. Output Voltage Noise Spectral Density at NCP781BMN050TAG

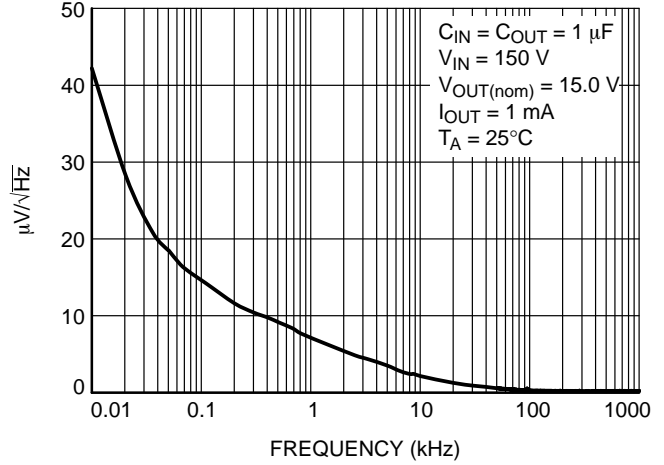


Figure 17. Output Voltage Noise Spectral Density at NCP781BMN150TAG

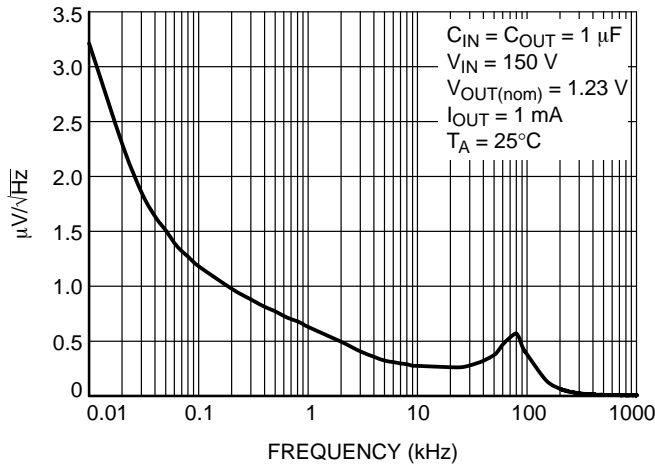


Figure 18. Output Voltage Noise Spectral Density at NCP781BMNADJTAG

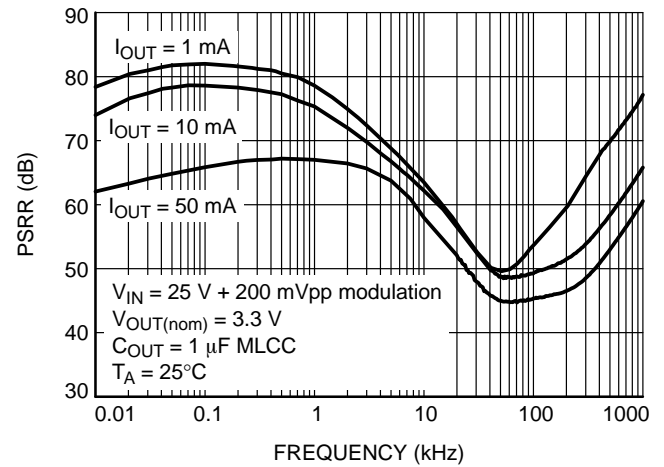


Figure 19. PSRR vs. Frequency at NCP781BMN033TAG

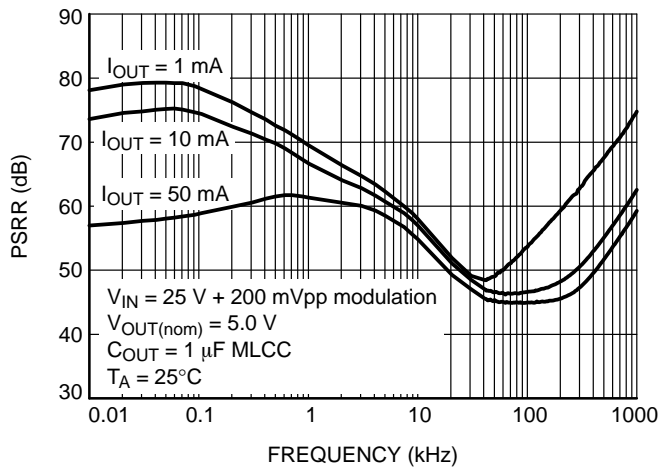


Figure 20. PSRR vs. Frequency at NCP781BMN050TAG

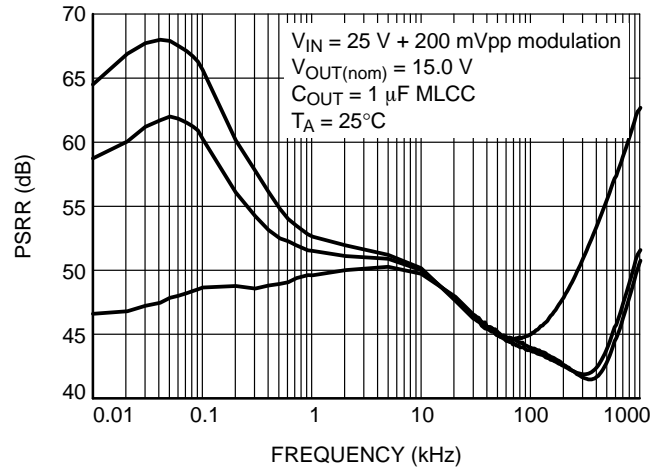
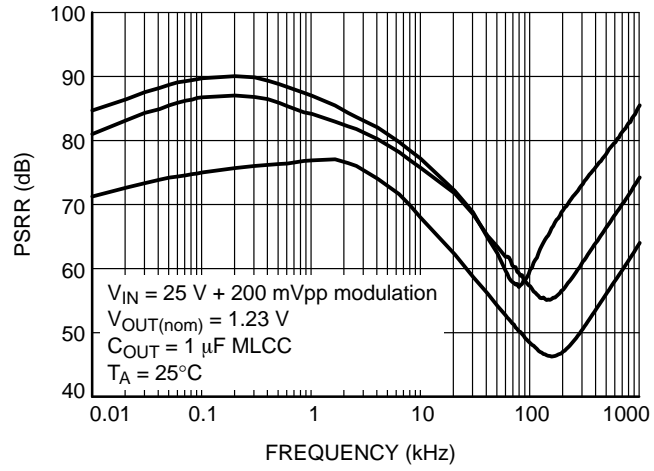


Figure 21. PSRR vs. Frequency at NCP781BMN150TAG

NCP781

TYPICAL CHARACTERISTICS



**Figure 22. PSRR vs. Frequency at
NCP781BMNADJTAG**

APPLICATIONS INFORMATION

The NCP781 is very high input voltage regulator with internal thermal shutdown and internal current limit. Typical application circuits are shown in Figure 23.

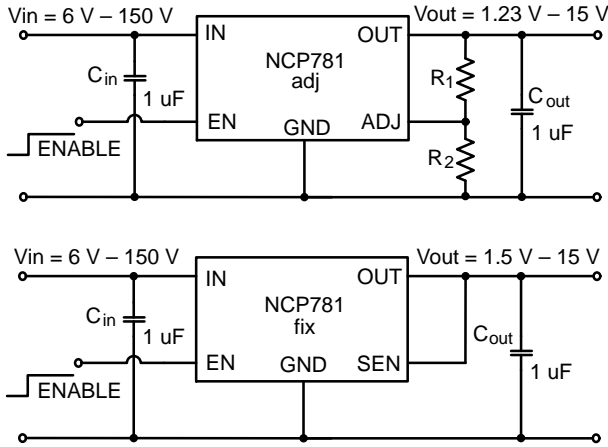


Figure 23. Typical Application Circuits

Input Decoupling (C_{in})

A ceramic or tantalum 0.1 μF capacitor is recommended and should be connected close to the NCP781 package. Higher capacitance and lower ESR will improve the overall line and load transient response.

Output Decoupling (C_{out})

The NCP781 is a stable component and does not require a minimum Equivalent Series Resistance (ESR) for the output capacitor. The minimum output decoupling value is 0.1 μF and can be augmented to fulfill stringent load transient requirements. The regulator works with ceramic chip capacitors as well as tantalum devices up to 10 μF . The larger values improve noise rejection, load regulation and transient response.

Enable Operation

The enable pin will turn the regulator on or off. The threshold limits are covered in the electrical characteristics table in this data sheet. The turn-on/turn-off transient voltage being supplied to the enable pin should exceed a slew rate of 150 mV/ μs to ensure correct operation. If the enable function is not to be used then the pin should be connected directly to V_{in} .

Output Voltage Adjust

The output voltage can be adjusted from 1.23 V to 15 V using resistors between the output and the ADJ input. The output voltage and resistors are chosen using Equation 1 and Equation 2.

$$V_{OUT} = 1.23 \times \left(1 + \frac{R_1}{R_2} \right) + (I_{ADJ} \times R_1) \quad (\text{eq. 1})$$

$$R_2 \cong R_1 \times \frac{1}{\frac{V_{OUT}}{1.25} - 1} \quad (\text{eq. 2})$$

Input bias current I_{ADJ} is typically less than 5 nA. Choose R_1 arbitrarily to minimize errors due to the bias current and to minimize noise contribution to the output voltage. Use Equation 2 to find the required value for R_2 . This device does not require a minimal load.

Thermal Considerations

As power in the NCP781 increases, it might become necessary to provide some thermal relief. The maximum power dissipation supported by the device is dependent upon board design and layout. Mounting pad configuration on the PCB, the board material, and the ambient temperature affect the rate of junction temperature rise for the part. When the NCP781 has good thermal conductivity through the PCB, the junction temperature will be relatively low with high power applications. The maximum dissipation the NCP781 can handle is given by:

$$P_{D(MAX)} = \frac{[T_{J(MAX)} - T_A]}{R_{\theta JA}} \quad (\text{eq. 3})$$

The power dissipated by the NCP781 can be calculated from the following equations:

$$P_D \approx V_{in} \times (I_{GND} @ I_{OUT}) + I_{OUT} \times (V_{IN} - V_{OUT}) \quad (\text{eq. 4})$$

or

$$V_{IN(MAX)} \approx \frac{P_{D(MAX)} + (V_{OUT} \times I_{OUT})}{I_{OUT} + I_{GND}} \quad (\text{eq. 5})$$

Hints

V_{in} and GND printed circuit board traces should be as wide as possible. When the impedance of these traces is high, there is a chance to pick up noise or cause the regulator to malfunction. Place external components, especially the output capacitor, as close as possible to the NCP781, and make traces as short as possible.

NCP781

ORDERING INFORMATION

Part No.	Output Voltage (V)	Marking	Package	Shipping†
NCP781BMNADJTAG	Adj	781N BADJ	DFN6 (Pb-Free)	3000 / Tape & Reel (Contact sales office for availability)
NCP781BMN033TAG	3.3	781N B033		
NCP781BMN050TAG	5	781N B050		
NCP781BMN150TAG	15	781N B150		

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS

ON Semiconductor®



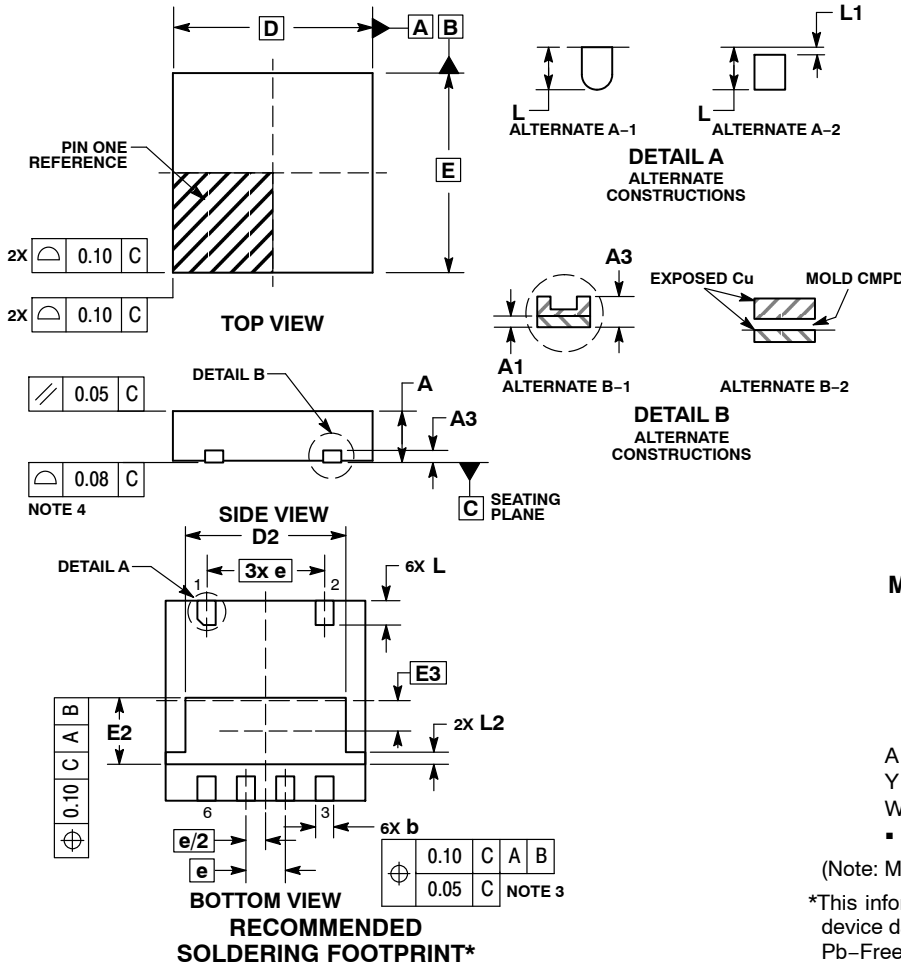
SCALE 2:1

DFN6 3.3x3.3, 0.65P

CASE 506DF

ISSUE B

DATE 23 JUN 2016

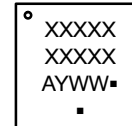


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30MM FROM THE TERMINAL TIP.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.
5. FOR DEVICE OPN CONTAINING W OPTION, DETAIL A ALTERNATE CONSTRUCTION A-2 AND DETAIL B ALTERNATE CONSTRUCTION B-2 ARE NOT APPLICABLE.

MILLIMETERS		
DIM	MIN	MAX
A	0.80	0.90
A1	0.00	0.05
A3	0.20	REF
b	0.25	0.35
D	3.30	BSC
D2	2.55	2.75
E	3.30	BSC
E2	1.00	1.20
E3	0.50	BSC
e	0.65	BSC
L	0.35	0.45
L1	0.00	0.15
L2	0.00	0.20

GENERIC MARKING DIAGRAM*



- A = Assembly Location
- Y = Year
- WW = Work Week
- = Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present.

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

DOCUMENT NUMBER:	98AON09329G	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.
DESCRIPTION:	DFN6 3.3X3.3, 0.65P	PAGE 1 OF 1

ON Semiconductor and ON are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

ON Semiconductor and  are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Email Requests to: orderlit@onsemi.com

ON Semiconductor Website: www.onsemi.com

TECHNICAL SUPPORT

North American Technical Support:
Voice Mail: 1 800-282-9855 Toll Free USA/Canada
Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support:

Phone: 00421 33 790 2910

For additional information, please contact your local Sales Representative